

Amendments to the Specification:

On page 1, prior to the first paragraph which begins on line 2, please insert the following:

FIELD OF THE INVENTION

On page 1, prior to the second paragraph which begins on line 4, please insert the following:

BACKGROUND OF THE INVENTION

On page 2, prior to the paragraph which begins on line 1, please insert the following:

SUMMARY OF THE INVENTION

Please replace the paragraph which begins on page 2, line 8 and ends on line 9, with the following rewritten paragraph:

The object is achieved according to the invention by ~~the a device as defined in independent claim 1.~~

Please replace the paragraph which begins on page 2, line 10 and ends on line 24, with the following rewritten paragraph:

~~The device of the invention which includes: an electronics housing, which defines an internal space; at least one circuit board, which is arranged in the internal space and which is populated, at least on a first surface, with electronic components, with the first surface facing a first wall of the electronics housing and the internal space being filled with a potting compound, at least between the first surface of the circuit board and the first wall, whereby heat given-off by the electronic components can be led away to the first wall; with there being embedded in the potting compound, between the circuit board~~

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and the first wall, an areal heat spreader, which has a front side facing the first wall and a rear side facing the circuit board, and which has a thermal conductivity which is greater than that of the potting compound, whereby inhomogeneous temperature distributions along the surface of the first wall are markedly reduced.

On page 3, prior to the paragraph which begins on line 21, please insert the following:

BRIEF DESCRIPTION OF THE DRAWINGS

On page 3, prior to the paragraph which begins on line 30, please insert the following:

DESCRIPTION OF THE PREFERRED EMBODIMENT